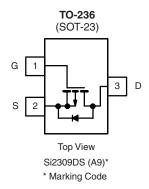




## P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)		
- 60	0.340 at V <sub>GS</sub> = - 10 V	- 1.25		
	0.550 at V <sub>GS</sub> = - 4.5 V	- 1		





Ordering Information: Si2309DS-T1

Si2309DS-T1-E3 (Lead (Pb)-free)

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>A</sub> = 25 °C, unles	s otherwise note	ed	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	- 60	V
Gate-Source Voltage		$V_{GS}$	± 20	V
Out 1 - 150 20 3 h	T <sub>A</sub> = 25 °C	1	- 1.25	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a, b</sup>	T <sub>A</sub> = 70 °C	'D —	- 0.85	
Pulsed Drain Current		I <sub>DM</sub>	- 8	A
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 5	
w. B. B ah	T <sub>A</sub> = 25 °C	D.	1.25	W
Maximum Power Dissipation <sup>a, b</sup>	T <sub>A</sub> = 70 °C	P <sub>D</sub>	0.8	VV
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manifestor Localitan to Applicant	t ≤ 5 s	- R <sub>thJA</sub>		100	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		130	166	°C/W
Maximum Junction-to-Lead <sup>a</sup>	Steady State	R <sub>thJL</sub>	45	60	

#### Notes:

a. Surface Mounted on FR4 Board.

b. t < 5 s

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply.

## Vishay Siliconix



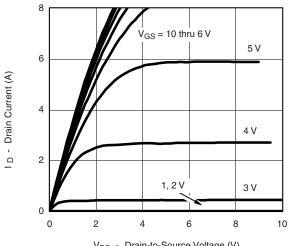
<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 60			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 1			V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	I <sub>DSS</sub>	$V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μА	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			- 50		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -4.5 \text{ V}, V_{GS} = -10 \text{ V}$	- 6			Α	
Drain-Source On-State Resistance <sup>a</sup>	r	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 1.25 A		0.275	0.340		
	r <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 1 A		0.406	0.550	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 4.5 V, I <sub>D</sub> = - 1 A		1.9		S	
Dynamic <sup>b</sup>				•			
Total Gate Charge	$Q_g$			5.4	12	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -1.25 \text{ A}$		1.15			
Gate-Drain Charge	Q <sub>gd</sub>			0.92			
Turn-On Delay Time	t <sub>d(on)</sub>			10.5	20	ns ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 30 V, $R_L$ = 30 $\Omega$		11.5	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 1 A, $\text{V}_\text{GEN}$ = - 4.5 V, $\text{R}_\text{G}$ = 6 $\Omega$		15.5	30		
Fall Time	t <sub>f</sub>			7.5	15		
Source-Drain Rating Characteristics	b						
Continuous Current	I <sub>S</sub>				- 1.25	Α	
Pulsed Current	I <sub>SM</sub>				- 8		
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = -1.25 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.82	- 1.2	٧	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 1.25 A, di/dt = 100 A/μs		30	55	ns	

#### Notes:

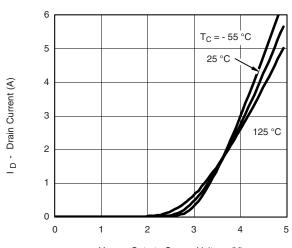
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $V_{DS}\,$  - Drain-to-Source Voltage (V) **Output Characteristics** 



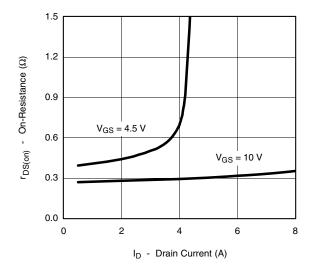
V<sub>GS</sub> - Gate-to-Source Voltage (V)



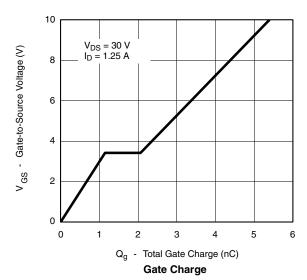


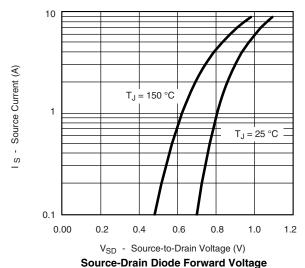


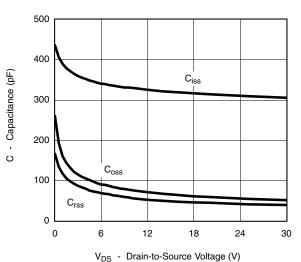
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



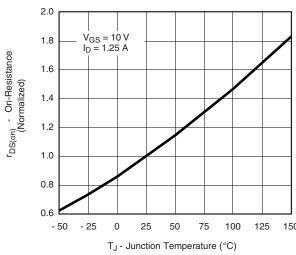
**On-Resistance vs. Drain Current** 



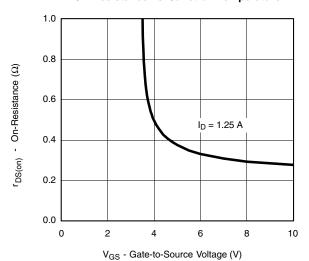




Capacitance



On-Resistance vs. Junction Temperature

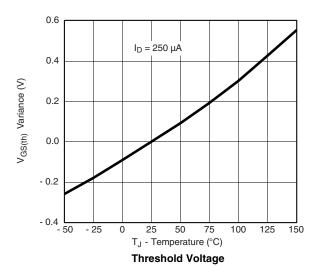


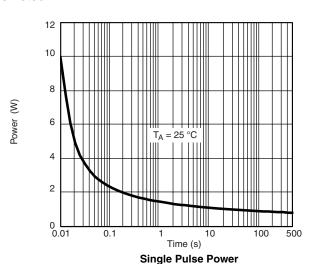
On-Resistance vs. Gate-to-Source Voltage

## Vishay Siliconix

# VISHAY.

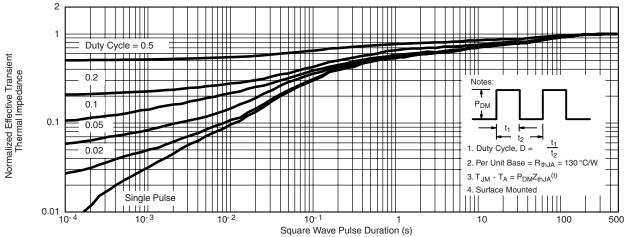
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





100 10 10 μs ID - Drain Current (A) 100 μs by r<sub>DS(on)</sub> 1 ms 10 ms 0.1 T<sub>A</sub> = 25 °C Single Pulse 100 ms DC, 100 s, 10 s, 1 s 0.01 0.1 100 10 V<sub>DS</sub> - Drain-to-Source Voltage (V)

### \* $V_{GS}$ > minimum $V_{GS}$ at which $r_{DS(on)}$ is specified **Safe Operating Area, Junction-to-Ambient**



#### Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?70835">http://www.vishay.com/ppg?70835</a>.



Vishay

## **Disclaimer**

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Revision: 18-Jul-08

Document Number: 91000 www.vishay.com